

## News & Update

### JOM Announces 2014 Technical Emphasis Calendar, Launches New Website

#### JOM 2014 Editorial Calendar Offers Expanded Technical Coverage Find It at [jom.tms.org](http://jom.tms.org)

JOM has released one of the most ambitious and robust editorial calendars in its history, with every one of TMS's 32 technical committees on board to support a technical topic for JOM publication in 2014. Counting symposia collections that are being submitted to JOM in 2014 as well, the journal will average nearly four technical topics per issue.

To access the 2014 Technical Emphasis Calendar, go to the newly redesigned JOM website at [jom.tms.org](http://jom.tms.org) and select "Editorial Calendar" at the top. From there, choose a technical theme from the drop down menu to review a particular issue's specific technical topics and their sponsoring committees, as well as submission

deadlines. Once you have identified a topic match for your paper, visit the JOM website's new, interactive Author's Tools section for checklists, style guides, and quick access to the resources necessary for successful completion of the JOM manuscript submission process.

Starting with this issue of JOM, the Technical Emphasis Calendar, along with a list of all JOM advisors, will also be published as a standing feature in the print journal.

The JOM technical themes for 2014 are: Characterization and Analysis (January); Lightweight Materials (February); Advances in Computational Materials (March); Advanced Materials (April); Metals and Alloys

(May); Materials and Processing (June); Modeling (July); Physical Metallurgy (August); Extraction and Processing (September); Mechanical Properties (October); Energy and Environment (November); and Materials for Extreme Environments (December).

"The 2014 JOM Technical Emphasis Calendar is exceptionally strong and a testament to the enthusiasm and commitment of our editorial volunteers," said James J. Robinson, TMS Executive Director. "It also speaks to the growing attractiveness of JOM as a technical publishing venue and its contribution to the knowledge base of the materials science and engineering community."

#### WELCOME TO THE NEW JOM WEBSITE

TMS is pleased to offer our members and JOM readers an enhanced on-line experience to complement the high-quality learning, news, and information that they have come to expect from the

journal's print pages. Our initial focus in launching this website has been on the people who make JOM possible—our authors and volunteer advisors and guest editors. Under the "Publish in

JOM" tab, for instance, we now offer an expanded, interactive Author Tools section and an upgraded Technical Emphasis Calendar.

In addition, we have put resources maintained by our publishing partner, Springer, at your fingertips so that you can quickly access current and archived issues of JOM. We have also introduced a more accessible online JOM Job Board, and have archived JOM content that previously lacked an online presence. Over the next year, we will be adding functional upgrades and a number of new resources as we continue to transition content from JOM's past to this digital resource. Go to [jom.tms.org](http://jom.tms.org) to find out more and to keep current with all that JOM can offer.

The screenshot displays the JOM website interface. At the top, it says "Visit TMS" and "The Member Journal of The Minerals, Metals & Materials Society". Navigation tabs include "ABOUT JOM", "READ JOM", "JOM JOB BOARD", "ADVERTISE IN JOM", "EDITORIAL CALENDAR", and "PUBLISH IN JOM". The main content area features a "CURRENT ISSUE - June 2013, Vol. 65., Number 6" section with a "THIS MONTH'S TECHNICAL THEME: Processing for Performance" and "THIS MONTH'S TECHNICAL TOPICS: Powder Materials and Processes for Enhanced Performance; Advances in Surface Engineering; Alloyed and Composite Coatings". There are also "SELECTED FEATURES" and a "SPOTLIGHT NEWS STORY" section titled "Get Up Close and Personal to the June JOM Cover Mosaic".

## TMS WELCOMES NEW MEMBERS

Please join us in congratulating the following new TMS members, approved by the TMS Board of Directors at its March meeting.

### ARGENTINA

Serebrinsky, Santiago, *Tenaris*

### AUSTRALIA

Currell, Brad, *Advantcetex International*

Doblin, Christian, *CSIRO*

Dunstan, Donald K., *DKD Resources Pty. Ltd.*

Gulizia, Stefan, *CSIRO*

Haidar, Jawad, *CSIRO*

Jacobson, Ian R., *Jacobson and Associates*

Johnston, Tim, *Hatch*

Lamacchia, Robert, *Alcoa World Alumina*

White, David T., *Snowden Mining Industry Consultants Inc.*

Xu, Wei, *University of Melbourne*

Yang, Yafeng Feng, *University of Queensland*

Zhang, Jianqiang, *University of New South Wales*

### AUSTRIA

Schupfer, Matthias, *Hammerer*

*Aluminium Industries GMBH*

Zeman, Andrej, *International Atomic Energy Agency*

### BAHRAIN

Al-Hayki, Mohamed, *Aluminium Bahrain*

Janahi, Abdulrahim Rahman,

*Aluminium Bahrain*

Noor, Aref, *Aluminium Bahrain*

### BRAZIL

Albino, Eduardo, *Schlumberger*

Alexandre, Jonas, *UNEF*

Azevedo Jr., Cleto Maues De, *Hydro Alunorte*

Batista, Eliezer S., *Alcoa Inc.*

Castro, Marcelo Miranda De, *Hydro Alunorte*

Cavichioli, Daniel, *Votorantim Metais/CBA*

Lazaro, Weimar, *Petrobras*

Matias, Telma

Oliveira Santos, Ayana Cristina, *Ecolab/Nalco*

Piffer, Vinicius, *Alcoa Inc.*

Rossi, Nelson, *Aluminium Solutions Network*

Silva, Enio Laubyer Ferreir, *Hydro*

*Alunorte*

Sommerfeld, Henrique, *Advantcetex International*

Tenorio, Jorge A.S., *University of São Paulo*

### CANADA

Barthelat, Francois, *McGill University*

Wei, Zhang, *McGill University*

Cui, Xinwei, *University of Alberta*

Drew, Robin A.L., *Concordia University*

Filippou, Dimitrios, *Rio Tinto*

Jaeger, Errol N., *SNC-Lavalin Inc.*

Kwan, Charles Chi Fong

Mahalanobis, Neil, *Integran Technologies Inc.*

Stamatiou, Evangelos, *Hatch Ltd.*

Wolfe, Tonya, *Alberta Innovates-Technology Futures*

Wu, Justin, *Teck Resources Ltd.*

Yue, Stephen, *McGill University*

Zhu, Yu, *Nanoacademic Technologies Inc.*

### CHILE

Pinto, Hernan, *Pontifical Catholic*

*University of Valparaíso*

### CHINA

An, Xuehui, *Shanghai Institute*

Dongjie, Ke, *Fuzhou Metal-New High-Temp Tech Co., Ltd.*

Du, Hongqiang, *Shenyang University of Technology*

Fan, Tongxiang, *Shanghai Jiaotong University*

Hou, Jungang, *University of Science & Technology Beijing*

Jiao, Shuqiang, *University of Science & Technology Beijing*

Li, Huifeng, *Baoshun Technology*

Li, Li, *Shanghai Institute of Applied Physics*

Ma, Zong-Yi, *Institute of Metal Research, CAS*

Shen, Miao, *Shanghai Institute*

Shi, Qingyu, *Tsinghua University*

Tao, Jiang, *Northeastern University*

Wang, Gang, *Northeastern University*

Wang, Zhaowen, *Northeastern University*

Zhang, Tiebang, *Northwestern*

*Polytechnical University*

Zhang, Yansong, *Shanghai Jiao Tong University*

Zhang, Yonghao, *Suzhou Institute for Non-Ferrous Metals*

Zou, Jianxin, *Shanghai Jiao Tong University*

Zuo, Haibin, *University of Science & Technology*

### COLOMBIA

Ossa, Alex, *EAFIT University*

### FRANCE

Danoix, Frederic, *CNRS Normandy University*

Delcorde, Xavier, *RTA/ECL*

Domain, Christophe, *EDF R&D*

Dumas, Jean-Christophe, *CEA*

Freyss, Michel, *CEA*

Gorsse, Stephane, *ICMCB-CNRS*

Guignot, Sylvain, *French Geological Survey BRGM*

Guilhem, Yoann, *CNRS-MATEIS*

Lacaze, Jacques, *Ensiacet*

Lambertin, David, *CEA Marcoule*

Nour-Eddine, Menad, *BRGM*

Pourroy, Genevieve, *CNRS*

Renaud, Gilles, *CEA-Grenoble Inac*

Steeve, Renaudier, *Rio Tinto Alcan Inc.*

Tedenac, Jean Claude, *University of Montpellier*

### FINLAND

Purhonen, Tero, *Posiva Oy*

### GERMANY

Appel, Fritz, *Helmholtz-Zentrum*

Ghafari, Mohammad

Greiner, Christian, *Karlsruhe Institute of Technology*

Grygoryev, Danylo, *Karlsruhe Institute of Technology*

Huter, Claas, *Max Planck*

Kirchheim, Reiner, *University of Göttingen*

Kurz, Gerrit, *Helmholtz Zentrum*

Skrotzki, Werner, *Dresden University of Technology*

Smaga, Marek, *Institute of Materials Science and Engineering*

Suhuddin, Uceu, *Helmholtz-Zentrum Geesthacht*

## TMS WELCOMES NEW MEMBERS

### GREAT BRITAIN

Antimonova, Olga, *Rio Tinto Group*  
 Bhagat, Rohit, *University of Warwick*  
 Huang, Zewen, *Birmingham University*  
 Lee, Joseph, *Siemens Metals Technologies*  
 Rao, Kartik K., *Metalysis*  
 Rodenburg, John, *University of Sheffield*  
 Vorontsov, Vassili A., *Imperial College London*  
 Winiarski, Bartłomiej, *University of Manchester*

### HUNGARY

Ribarik, Gabor, *Eötvös Loránd University*  
 Varga, Lajos Karoly K., *Wigner Research Center for Physics*

### ICELAND

Hoskuldsson, Gauti, *Norðurál*

### INDIA

Banerjee, Srikumar, *Bhabha Atomic Research Center*  
 Chatterjee, Mrinal, *Mishra Dhatu Nigam Ltd.*  
 Jha, Sanjay  
 Mahadevan, Priya, *S. N. Bose National Centre for Basic Science*  
 Patra, Ashok  
 Ramamurty, Upadrasta, *Indian Institute of Science*  
 Ravula, Vijay, *ARCI*  
 Sarkar, Pallab, *Mishra Dhatu Nigam Ltd.*  
 Satpathy, Santosh  
 Sawhney, Angad, *Antaeus Corp.*  
 Sawhney, Manjit, *Antaeus Corp.*  
 Tewari, Raghvendra, *Bhabha Atomic Research Centre*

### ITALY

Campice, Giovanni, *T. T. Tomorrow Technology*

### JAPAN

Hashimoto, Naoyuki, *Hokkaido University*  
 Hayashi, Hirokazu, *Japan Atomic Energy Agency*  
 Kambara, Makoto, *University of Tokyo*

Mizukami, Takahiro, *Honda Motor Company, Ltd.*  
 Ohishi, Yuji, *Osaka University*  
 Okada, Hideki, *Kawasaki Heavy Industries, Ltd.*  
 Ono, Hiroshi, *Nippon Steel & Sumikin Chemical Co., Ltd.*  
 Ozaki, Yoshitomo, *Sumitomo Metal Mining Co., Ltd.*  
 Ruan, L., *Kumamoto University*  
 Satoh, Shinichi, *Mitsubishi Materials Corp.*  
 Sekimoto, Hidehiro, *Iwate University*  
 Toyama, Takeshi, *Tohoku University*  
 Yabuuchi, Kiyohiro, *Tohoku University*  
 Yoshitaka, Matsukawa, *Tohoku University*

### JORDAN

Hamad, Bothina, *University of Jordan*

### MALAYSIA

Lias, Marina, *Universiti Teknologi Malaysia*

### MEXICO

Cardoso Aguirre, Marcos Ignacio, *Nemak*  
 Mercado-Solis, Rafael, *Universidad Autonoma De Nuevo Leon Fac. De Ingenieria Mec Y Elect*

### NORWAY

Chmelar, Juraj, *Hydro*  
 Leistad, Stein Norman, *Hydro Aluminium As*  
 Pettersen, Tanja, *SINTEF Group*  
 Vatne, Hans Erik E., *Hydro*  
 Waernes, Aud Nina, *SINTEF Materials and Chemistry*

### OMAN

Al Kiyumi, Yaqoob S., *Sohar Aluminium*  
 Albelushi, Khalid, *Sohar Aluminium*  
 Phillip, Theophilus, *Sohar Aluminium*

### POLAND

Danko, Rafal, *AGH University Science & Technology*  
 Holtzer, Mariusz, *AGH University Science & Technology*  
 Okrzesik, Waldemar, *GE Aviation*  
 Zybankowska, Sylwia, *AGH University Science & Technology*

### RUSSIA

Diyachenko, Vladimir, *OJSC MMC Norilsk Nickel*

Dyachenko, Vladimir, *OJSC MMC Norilsk Nickel*  
 Gorbachev, Sergey, *UC RUSAL*  
 Matveeva, Irina, *UC RUSAL*  
 Panishov, Nikolay, *Magnitogorsk Iron & Steel Works*

### SINGAPORE

Li, Peifeng, *Nanyang Technological University*

### SOUTH AFRICA

Roro, Kittessa, *CSIR National Laser Centre*  
 Songca, Sandile, *Walter Sisulu University for Technology and Science*

### SOUTH KOREA

Baek, Jong-Hyuk, *Korea Atomic Energy Research Institute*  
 Choi, In-Suk, *Korea Institute of Science and Technology*  
 Choo, Dongkyun, *RIST*  
 Han, Hyung-Seop, *Korea Institute of Science and Technology*  
 Jongkook, Lee, *Hyundai Motor Co.*  
 Kang, Dong-Hee, *KRISS*  
 Kiho, Yun, *RIST*  
 Kim, Jae, *Dong-A University*  
 Kim, Jong Ho, *RIST*  
 Lee, Changho, *POSCO*  
 Lee, Hyo-Soo, *Korea Institute of Industrial Technology*  
 Moon, Byoung-Gi, *Korea Institute of Materials Science*  
 Nam, Tae Hyun, *Gyeongsang National University*  
 Oh, Sang Ho, *Postech*  
 Park, Hoonmo, *Central Advanced Research and Engineering Institute*

### SWEDEN

Abrikosov, Igor A., *Linköping University*  
 Bogdanoff, Toni, *Jönköping University School of Engineering*  
 Broitman, Esteban, *Linköping University*

### SWITZERLAND

Goedecker, Stefan, *University of Basel*  
 Le Bourlot, Christophe, *Paul Scherrer Institute*

## TMS WELCOMES NEW MEMBERS

### TAIWAN

Kao, Ming-Jer, *Industrial Technology Research Institute*

### TURKEY

Isiksacan, Cemil, *Assan Aluminum*  
 Ulubayram, Kezban, *Hacettepe University*  
 Yesilcubuk, Alper, *Arçelik A.*

### UKRAINE

Bakai, Sergii, *Institute of Physics and Technology*  
 Sagalovich, Alex V.

### UNITED ARAB EMIRATES

Al-Farsi, Yousef Ali Mohammed, *Maaden Saudi Arabia*  
 Al Khaili, Owaida, *Gulf Fluor*  
 Al Marzouqi, Amer, *Dubai Aluminium*  
 Alhammadi, Esam, *EMAL*  
 Alhashmi, Saif, *Emirates Aluminium*  
 Alriyami, Abdulla Mohammed  
 Alrustamani, Khalid H., *Emirates Aluminium*  
 Bin Rahal, Ali, *Emirates Aluminium*  
 Eisele, Dennis, *Gulf Fluor*  
 Suleiman, Wael, *Gulf Fluor*

### UNITED STATES

Akasheh, Firas, *Tuskegee University*  
 Alcoutlabi, Mataz, *The University of Texas-Pan American*  
 Archer, Lynden, *Cornell University*  
 Ardebili, Haleh, *University of Houston*  
 Avity, Kwami H., *Tech Ecogenie*  
 Baker, Brian A., *University of Utah*  
 Baker, Dean, *Advanced Powder Solutions Inc.*  
 Barrera, Enrique V., *Rice University*  
 Bartel, Timothy, *Sandia National Laboratories*  
 Baxter, Robert D., *Ashland Inc.*  
 Bayha, Thomas D., *ATI*  
 Beals, James, *UTRC*  
 Benafan, Othmane, *NASA Glenn Research Center*  
 Ben-Avi, Simon, *Hofstra University*  
 Benner, Jeff, *BP*  
 Betts, William, *Novelis Inc.*  
 Bloniasz, Corey  
 Boldsai Khan, Enkhsai Khan, *Wichita State University*  
 Bolles, Tom, *Freepport-McMoRan*

*Copper & Gold*  
 Bouscher, Shawn  
 Calkins, Frederick, *Boeing Co.*  
 Chellman, David J., *Lockheed Martin Aeronautics Co.*  
 Chen, Chonglin, *The University of Texas*  
 Chen, Shuh-Rong, *Los Alamos National Laboratory*  
 Chen, Youping, *University of Florida*  
 Chen, Zi, *Washington University*  
 Cheng, Xingguo, *Southwest Research Institute*  
 Cheng, Yongqiang, *Oak Ridge National Laboratory*  
 Chopra, Harsh Deep, *State University of New York*  
 Constantinides, Steve, *Arnold Magnetic Technologies Corp.*  
 Coulter, Kent E., *Southwest Research Institute*  
 Craver, Kyle A., *Ashland Inc.*  
 Curley, Brandon, *Ormco Corp.*  
 Darbal, Amith, *NanoMEGAS*  
 Das, Avishek, *Tata Sons Ltd.*  
 Davis, Jeff, *Rockwood Lithium*  
 Delaire, Olivier, *Oak Ridge National Laboratory*  
 Densmore, John, *Lawrence Livermore National Laboratory*  
 Dilibal, Savas, *University of Akron*  
 Dillon, Shen, *University of Illinois*  
 Dobryial, Alok  
 Eaton, Joey, *Logan Aluminum Inc.*  
 Ebert, William L., *Argonne National Laboratory*  
 Elsentriecy, Hassan  
 Eng, Andrew  
 Fong, Hanson, *University of Washington*  
 Frederic, Kody, *Noranda Alumina LLC*  
 Freestone, James, *General Cable Technologies Corp.*  
 Gage, Edward, *Seagate Technology LLC*  
 Ganguly, Partha, *Schlumberger*  
 Giri, Anit, *US Army Research Laboratory*  
 Graedel, Thomas E., *Yale University*  
 Gregory, William, *Southwire Co.*  
 Guo, Bingkun, *Oak Ridge National Laboratory*  
 Hahn, Choo, *University of Tennessee*  
 Hammond, Barbara, *BP*  
 Hanejko, Francis, *Hoeganaes Corp.*  
 Hay, David, *Magnesita Refractories*  
 Heredia, Georgina, *University of Texas at El Paso*

Hindenlang, Mark, *United States Army Research Laboratory*  
 Ho, K.M., *Ames Laboratory*  
 Hu, Tao, *The University of California*  
 Huang, David D., *BP Exploration and Production Inc.*  
 Ingraffea, Anthony R., *Cornell University*  
 Ismach, Ariel, *The University of Texas, Austin*  
 Janssen, Nick, *BP*  
 Jenkins, Catherine, *Lawrence Berkeley National Laboratory*  
 Jiang, Chao, *University of Wisconsin*  
 Kanaby, Tom, *IBC Materials Research*  
 Karaca, Haluk E., *University of Kentucky*  
 Karandikar, Prashant, *M Cubed Technologies, Inc.*  
 Kasai, Masanori, *Murata Electronics North America, Inc.*  
 Kim, Hyung Mun, *Carnegie Mellon University*  
 Kim, Kyouhyun, *University of Illinois*  
 Kim, Moon, *The University of Texas, Dallas*  
 Kim, Taeyoung, *The University of Texas, Austin*  
 Kozinsky, Boris, *Robert Bosch LLC*  
 Krstulich, John J.  
 Lawrynovicz, Daniel E., *Stryker Howmedica Osteopaedics*  
 Lee, Eungje, *Argonne National Laboratory*  
 Lee, Jae-Hwang, *Rice University*  
 Lee, Kyu-Oh, *Intel Corp.*  
 Lewis, Shane M.  
 Li, Bin, *Mississippi State University*  
 Li, Chen, *Oak Ridge National Laboratory*  
 Lian, Jie, *Rensselaer Polytechnic Institute*  
 Lim, Yong Chae, *Oak Ridge National Laboratory*  
 Lin, Eric, *National Institute of Standards and Technology*  
 Liu, Xinghua, *Alcoa Inc.*  
 Lommen, James M., *Lommen Consulting*  
 Long, Joe, *Southwire Co.*  
 Lopez, Carlos, *Boston University*  
 Love, Richard O., *EFI Group LLC*  
 Mahapatra, Rama, *Castrip LLC*  
 Marsh, Ian C., *Gillespie & Powers Inc.*

## TMS WELCOMES NEW MEMBERS

Mckeown, Joseph, *Lawrence Livermore National Laboratory*

Medlock, Rex W., *Tower Extrusions Ltd.*

Meisels, Aryeh P., *Pratt & Whitney Rocketdyne Inc.*

Merzlak, James, *GrafTech International Ltd.*

Meyer, David J.

Miglis, Yohann E., *Technip USA Inc.*

Milen, Terry, *Babcock & Wilcox Technical Services Group, Inc.*

Mo, Kun, *University of Illinois*

Mo, Rigen, *University of Pennsylvania*

Mukherjee, Sundeep, *University of North Texas*

Mullins, Oliver, *Schlumberger*

Naglieri, Valentina, *Lawrence Berkeley National Laboratory*

Nanda, Jagjit, *Oak Ridge National Laboratory*

Neto, Carlos, *Magnesita Refractories Co.*

O'Donnell, Jeffrey R., *Technip USA Inc.*

Okuniewski, Maria A., *Idaho National Laboratory*

Oliver, Warren, *Nanomechanics, Inc.*

Orlov, Alexander, *State University of New York*

Otto, Frederik, *Oak Ridge National Laboratory*

Padula, Santo A., *NASA Glenn Research Center*

Pappano, Peter, *U.S. Department of Energy*

Park, Alison M., *Pratt & Whitney Rocketdyne Inc.*

Paulin, Nick, *Century Aluminum Co.*

Peuster, Matthias, *The University of Chicago*

Phillips, Christopher, *Alcoa Inc.*

Poenitzsch, Vasiliki, *Southwest Research Institute*

Qin, Lu-Chang, *University of North Carolina at Chapel Hill*

Qu, Meng, *Schlumberger-Doll Research Center*

Rachuri, Sudarsan, *National Institute of Standards and Technology*

Ramasamy, Suresh Kumar, *Hutchinson Technology Inc.*

Ren, Xiaohong, *Schlumberger*

Ren, Zhifeng, *University of Houston*

Samarov, Victor, *Synertech PM Inc.*

Schmidt, Jeffrey W., *Ashland*

Schroers, Jan, *Yale University*

Schultz, Benjamin F., *University Of Wisconsin*

Sciaretta, Domenico P., *Refractory Specialties Inc.*

Shamsuzzoha, Mohammad, *University of Alabama*

Sheldon, Brian, *Brown University*

Sherman, Richard, *Monsanto Co.*

Snyder, G. Jeffrey, *California Institute of Technology*

Somani, Vikas, *Brazeway Inc.*

Sparks, Andy

Spoering, Ryan H., *Halliburton Co.*

Stevanovic, Vladan, *NREL/CSM*

Stocks, Malcolm, *Oak Ridge National Laboratory*

Subramanian, Gopinath, *Los Alamos National Laboratory*

Sun, Ying, *Drexel University*

Sundal, James O.

Tang, Meijie, *Lawrence Livermore National Laboratory*

Taylor, Christopher John, *Los Alamos National Laboratory*

Thompson, Trevor, *Southwire Co.*

Tobe, Hirobumi, *University of Kentucky*

Trimarchi, Giancarlo, *Northwestern University*

Tucker, Chris, *Encore Wire Corp.*

Vais, Philip, *Honda Motor Company, Ltd.*

Van Der Ven, Anton, *University of Michigan*

Vantari, Bhargava Reddy

Varanasi, Kripa, *Massachusetts Institute of Technology*

Vermaak, Natasha, *Lehigh University*

Victor, Ron, *Wireless Industrial Technologies*

Voit, Walter E., *The University of Texas, Dallas*

Von Lilienfeld, Anatole, *Argonne National Laboratory*

Voss, Zane, *Nucor Steel*

Wang, Lin-Wang, *Lawrence Berkeley National Laboratory*

Watkins, Thomas R., *Oak Ridge National Laboratory*

Weritz, John, *The Aluminum Association*

Whitaker, Travis, *Southwire Co.*

Wienczek, Thomas, *Argonne National Laboratory*

Williams, Garth, *SLAC National Accelerator Laboratory*

Williams, John, *Bray International, Inc.*

Willilams, Steve, *Kaiser Aluminum*

Winchester, Benjamin, *Sandia National Laboratories*

Wu, Yuan, *University of California, Santa Barbara*

Yamamoto, Takuya, *University of California, Santa Barbara*

Yang, Shizhong, *Southern University*

Yao, Lan, *Oak Ridge National Laboratory*

Yu, Choongho, *Texas A&M University*

Yu, Guihua, *The University of Texas, Austin*

Yuan, Lang, *GE Global Research Center*

Zhai, Tongguang, *University of Kentucky*

Zheng, Jim, *FAMU-FSU College of Engineering*

Zheng, Lili, *Oak Ridge National Laboratory*

Zhou, Fei, *University of California*

Zilker, Greg, *Advantex International USA Inc.*

Zuo, Jian Min J., *University of Illinois, Urbana-Champaign*

### VENEZUELA

Subero, Jose Ramon, *CVG Venalum*